

# **HETERO JUNCTION FIELD EFFECT TRANSISTOR**

# NE3511S02

# X TO Ku BAND SUPER LOW NOISE AMPLIFIER N-CHANNEL HJ-FET

### **FEATURES**

- Super low noise figure and high associated gain
   NF = 0.30 dB TYP., G<sub>a</sub> = 13.5 dB TYP. @ f = 12 GHz
- Micro-X plastic (S02) package

#### **APPLICATIONS**

- · X to Ku-band DBS LNB
- · Other X to Ku-band communication systems

### **ORDERING INFORMATION**

Part Number	Order Number	Package	Quantity	Marking	Supplying Form
NE3511S02-T1C	NE3511S02-T1C-A	S02 (Pb-Free)	2 kpcs/reel	В	8 mm wide embossed taping
NE3511S02-T1D	NE3511S02-T1D-A		10 kpcs/reel		Pin 4 (Gate) faces the perforation side     of the tape

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: NE3511S02-A

## ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	Vos	4	V
Gate to Source Voltage	Vgs	-3	V
Drain Current	lσ	loss	mA
Gate Current	lg	100	μА
Total Power Dissipation	P <sub>tot</sub> Note	165	mW
Channel Temperature	Tch	+125	°C
Storage Temperature	T <sub>stg</sub>	-65 to +125	°C

Note Mounted on 1.08 cm<sup>2</sup> × 1.0 mm (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

# RECOMMENDED OPERATING CONDITIONS (Ta = +25°C)

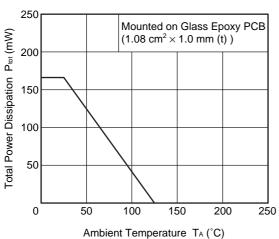
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	Vos	1	2	3	V
Drain Current	lσ	5	10	20	mA
Input Power	Pin	-	-	0	dBm

# ELECTRICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

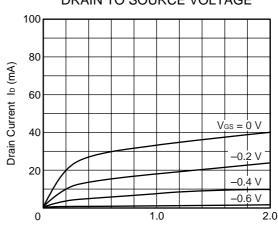
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	Igso	V <sub>G</sub> S = −3 V	_	0.5	10	μА
Saturated Drain Current	IDSS	V <sub>DS</sub> = 2 V, V <sub>GS</sub> = 0 V	20	40	70	mA
Gate to Source Cutoff Voltage	VGS (off)	$V_{DS} = 2 \text{ V}, I_{D} = 100 \mu A$	-0.2	-0.7	-1.7	V
Transconductance	<b>g</b> m	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 10 mA	50	65	-	mS
Noise Figure	NF	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 10 mA, f = 12 GHz	-	0.30	0.45	dB
Associated Gain	Ga		12.5	13.5	П	dB

## TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

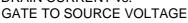


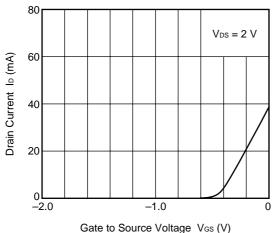


# DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



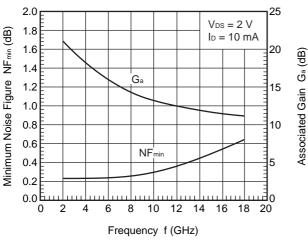
# DRAIN CURRENT vs.



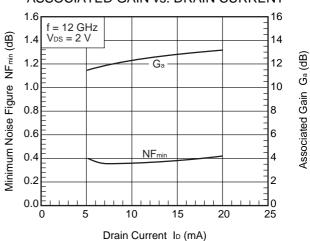


Drain to Source Voltage VDS (V)

## MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. FREQUENCY



MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. DRAIN CURRENT



**Remark** The graphs indicate nominal characteristics.

### **S-PARAMETERS**

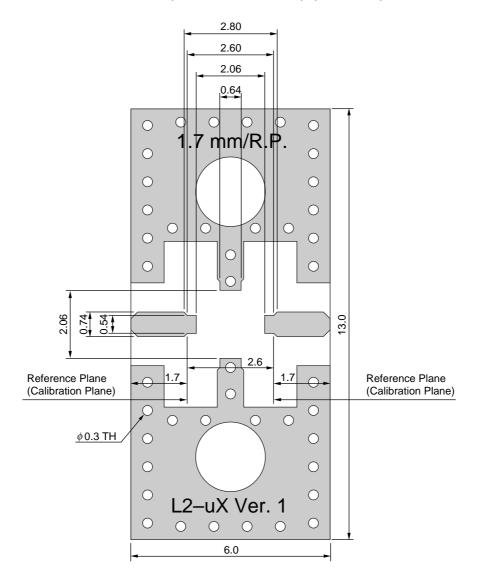
S-parameters/Noise parameters are provided on our web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

Click here to download S-parameters.

[RF and Microwave]  $\rightarrow$  [Device Parameters]

URL http://www.ncsd.necel.com/microwave/index.html

# RF MEASURING LAYOUT PATTERN (REFERENCE ONLY) (UNIT: mm)



RT/duroid 5880/ROGERS

t = 0.254 mm

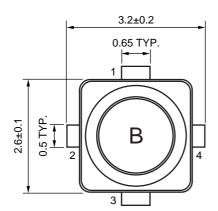
 $\epsilon r = 2.20$ 

tan delta = 0.0009 @10 GHz

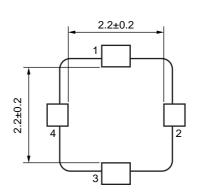
# **PACKAGE DIMENSIONS**

S02 (UNIT: mm)

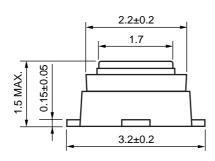
(Top View)



(Bottom View)



(Side View)



# **PIN CONNECTIONS**

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate

### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	H\$350

Caution Do not use different soldering methods together (except for partial heating).

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M8E 02.11-1

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

#### ▶For further information, please contact

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Subject: Compliance with EU Directives

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices
Lead (Pb)	< 1000 PPM	< 1000 PPM -A Not Detected	
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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